Qualification of ASE Chungli as an Alternate Assembly Site for MSOP Devices

MSOP at ASE Chungli (ASE-AET) Qualification

QUALIFICATION RESULT				
TEST	SPECIFICATION	SAMPLE SIZE	RESULT	
Temperature Cycle (TC)*	JEDEC JESD22-A104	3 x 77	PASS	
Highly Accelerated Stress Test (HAST)*	JEDEC JESD22-A110	3 x 77	PASS	
Autoclave (AC)*	JEDEC JESD22-A102	3 x 77	PASS	
Unbiased Highly Accelerated Stress Test (UHAST)*	JEDE JESD22-A118	3 x 77	PASS	
Solder Heat Resistance (SHR)*	JEDEC/IPC J-STD-020	3 x 11	PASS	
High Temperature Storage (HTS)	JEDEC JESD22-A103	1 x 77	PASS	
Electrostatic Discharge Field Induced Charge Device Model	JEDEC JESD22-C101	3/voltage	PASS ±1250V	

^{*}Preconditioned per JEDEC/IPC J-STD-020

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Automotive Qualification Results Summary of MSOP Package at ASE Chungli (ASE-AET)

QUALIFICATION RESULT				
TEST	SPECIFICATION	SAMPLE SIZE	RESULT	
Temperature Cycle (TC)*	JEDEC JESD22-A104	3 x 77	PASS	
Highly Accelerated Stress Test (HAST)*	JEDEC JESD22-A110	3 x 77	PASS	
Unbiased Highly Accelerated Stress Test (UHAST)*	JEDEC JESD22-A118	3 x 77	PASS	
Solder Heat Resistance (SHR)*	JEDEC/IPC J-STD-020	3 x 11	PASS	
High Temperature Storage (HTS)	JEDEC JESD22-A103	3 x 77	PASS	
Electrostatic Discharge Field Induced Charge Device Model	JEDEC JESD22-C101	3/voltage	PASS ±1250V	

^{*} These samples were subjected to preconditioning (per J-STD-020 Level 1) prior to the start of the stress test. Level 1 preconditioning consists of the following: Bake: 24 hrs @ 125°C, Unbiased Soak: 168 hrs @ 85°C, 85%RH, Reflow: 3 passes through an oven with a peak temperature of 260°C. TC samples were subjected to wire-pull test after 500 cycles with results within specification limits